

Title (en)
CRYOGENIC DEVICES

Title (de)
KRYOGENVORRICHTUNGEN

Title (fr)
DISPOSITIFS CRYOGENIQUES

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Abstract (en)
[origin: WO0221708A2] This invention relates generally to cryogenic devices and, more particularly, to cryogenic devices of very small size based on superconducting elements, low thermal transmission interconnects and low dissipated power semiconductor devices.

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